First synthesis of silicon nanocrystals in amorphous silicon nitride from a preceramic polymer


To cite this version:

M Biesuz, P Bettotti, S Signorini, M Bortolotti, R Campostrini, et al.. First synthesis of silicon nanocrystals in amorphous silicon nitride from a preceramic polymer. Nanotechnology, Institute of Physics, 2019, 30 (25), pp.255601. 10.1088/1361-6528/ab0cc8. hal-02389019

HAL Id: hal-02389019

https://hal-unilim.archives-ouvertes.fr/hal-02389019

Submitted on 12 Dec 2020

HAL is a multi-disciplinary open access archive for the deposit and dissemination of scientific research documents, whether they are published or not. The documents may come from teaching and research institutions in France or abroad, or from public or private research centers.

L’archive ouverte pluridisciplinaire HAL, est destinée au dépôt et à la diffusion de documents scientifiques de niveau recherche, publiés ou non, émanant des établissements d’enseignement et de recherche français ou étrangers, des laboratoires publics ou privés.
First synthesis of silicon nanocrystals in amorphous silicon nitride from a preceramic polymer

M Biesuz1, P Bettotti2, S Signorini2, M Bortolotti1, R Campostrini1, M Bahri3, O Ersen3, G Speranza1,4, A Lale6, S Bernard6 and G D Sorarù1

1 University of Trento, Department of Industrial Engineering, Via Sommarive 9, I-38123 Trento, Italy
2 University of Trento, Department of Physics, Via Sommarive 14, I-38123 Trento, Italy
3 Institut de Physique et Chimie des Matériaux de Strasbourg (IPCMS), UMR 7504 CNRS—Université de Strasbourg, 23 rue du Loess, F-67034 Strasbourg cedex 2, France
4 CMM—FBK, Via Sommarive 18, I-38123 Trento, Italy
5 IFN—CNR, CSMFO Lab. & FBK CMM, Via alla Cascata 56/C Povo, I-38123 Trento, Italy
6 Univ. Limoges, CNRS, IRCER, UMR 7315, F-87000, Limoges, France

E-mail: mattia.biesuz@unitn.it

Abstract
We report the first synthesis of silicon nanocrystals embedded in a silicon nitride matrix through a direct pyrolysis of a preceramic polymer (perhydropolysilazane). Structural analysis carried out by XRD, XPS, Raman and TEM reveals the formation of silicon quantum dots and correlates the microstructures with the annealing temperature. The photoluminescence of the nanocomposites was investigated by both linear and nonlinear measurements. Furthermore we demonstrate an enhanced chemical resistance of the nitride matrix, compared to the typical oxide one, in both strongly acidic and basic environments. The proposed synthesis via polymer pyrolysis is a striking innovation potentially allowing a mass-scale production nitride embedded Si nanocrystals.

Keywords: polymer pyrolysis, Si nanodots, silicon nitride, photoluminescence

1. Introduction

Technological evolution is steadily pushing the uses of silicon to new applications [1–3]. Silicon is the leading material in electronics [2], photovoltaic [2, 4, 5] and optical communications but new uses of properly engineered Si-based nanomaterials are being explored into the themes of sensing materials [5–7], photocatalysis [5, 8], nonlinear optics [9–14], quantum technologies [15] and biomedics [5, 16–22]. One of the main drawbacks of silicon in photonics is its limited efficiency as light emitter, because of the indirect nature of its bandgap [5, 23, 24]. Yet properly engineered nanocrystalline Si (nc-Si), have partially overcome this limit and proof of concept of active Si-based photonics were demonstrated [2, 5, 23–41].

Most of the publications regarding nc-Si deal with systems where the nanodots are embedded in a silica matrix, nc-Si@SiO2 [5, 11, 26, 31, 42–45]. However, such kind of microstructure presents some limits mainly in terms of chemical stability and refractive index value. In fact, silicon dioxide is corroded in both basic environments and hydrofluoric acid solutions; while the limited thermal stability of silicon dioxide forbids the application of nc-Si@a-SiO2 composites in applications where high power density are required (e.g. high pumping nonlinear optics regimes).
Silicon nitride is a promising alternative for nc-Si optoelectronic [30, 46–48], as it matches the optical transparency of oxide with an increased confinement effects, due to its larger refractive index. Moreover, Si nitride is both chemically and thermally more resistant than SiO₂. Up to now, the fabrication methods of nc-Si in silicon nitride matrix rely mainly on physical deposition (e.g. thermal [47] or plasma enhanced [9, 10, 30, 49] chemical vapor deposition, electron beam evaporation [45], ion implantation and annealing [26]), others are of research interest only (like reactive evaporation [44], sputtering [29, 30, 51], laser ablation techniques [12]). However, all these technologies are characterized by a low yield, require complex instrumentation and are applicable to limited geometries (coatings/thin films). Furthermore, the formation of nc-Si in nitride required a much careful choice of the precursor mix and the interfacial stress at the nitride/substrate interface heavily limits the maximum thickness of the film [52] and it influences the optical properties of the nc-Si so that the origin of the photoluminescence (PL) emission is still unclear (e.g. see [52–55] and [56]).

The development of polymer-derived ceramics (PDCs) technology [57] offers new opportunities for the large scale production of nanostructures [58–61] and assures a great control over their chemical composition, thus enabling a fine tuning of the nanocrystals properties [7, 17] and, by enabling the processing of bulk materials, the polymer pyrolysis route allows bypassing the ‘substrate/coating geometry’ therefore avoiding the problem of interfacial stresses of the thin multilayer depositions. Thus it will help to clarify the origin of the PL coming from these nanostructures. Among the different preceramic polymers reported in the literature [41–43], polysilazanes allow the formation of silicon nitride-based ceramics containing controlled free carbon and/or free silicon contents [58, 59, 62–65].

This work demonstrates the first synthesis of luminescent nc-Si in nitride matrix through the direct pyrolysis of a preceramic polymer: a polysilazane containing only Si, N and H, namely a perhydropolysilazane, is heated in a controlled atmosphere to induce the organic-to-inorganic [58, 59, 62, 63] transformation which leads to a Si–N nanostructured ceramic material: nc-Si@α-Si₃N₄, with x ≈ 4/3 [58, 59]. Such an approach offers originality and innovation in the field of nc-Si technology and paves the way for a cheap and large-scale production of nanostructured nc-Si-containing ceramics with substantially no shape limitations; as a matter of fact, the PDCs process has already been applied to produce films, bulk materials and fibers [57].

2. Experimental procedures

A perhydropolysilazane (PHPS), constituted by linear chains of (−SiH₂−NH−) units, was purchased from DurXtreme (NN120-20; DurXtreme, Uhln, Germany) in a dibuthylether (DBE) solution (nominal composition: 20% PHPS, 80% DBE). Before using the PHPS solution, DBE has been partially evaporated until a 80% PHPS/20% DBE solution was obtained. Pyrolysis of the pre-ceramic polymer was obtained using the furnace of a DTA/TGA Netzsch STA 409 instrument (Netzsch-Gerätebau GmbH, Selb, Germany) by loading about 150 mg of PHPS solution into the alumina crucible. To perform the pyrolysis in a well-controlled atmosphere, air was removed from the furnace chamber by mean of a vacuum pump (till the pressure inside the furnace was < 0.1 bar) and then the chamber was filled with Ar (purity 99.9999%). This operation was repeated three times before each test. The thermal treatments were carried out setting a heating rate of 10 °C min⁻¹ up to four different temperatures, namely 950 °C, 1050 °C, 1150 °C and 1250 °C, with no dwelling time at high temperature, followed by free cooling. The Ar flux through the tubular furnace during the treatments was set to 50 cm³ min⁻¹. An additional sample was produced at higher temperature to allow a complete crystallization of the amorphous matrix; such sample was treated, following the same procedures, up to 1400 °C with 2 h dwelling at high temperature.

Thermal gravimetric analysis coupled with mass spectrometry (TGA-MS) measurements were performed with a home-made interface which connect a LabSys Setaram thermobalance with a Triol VG quadrupole mass spectrometer. TG measurements were carried out fluxing the thermobalance furnace with a constant 120 cm³ min⁻¹ He flow. Samples were weighted and loaded into alumina crucible holders (volume 0.1 cm³), α-Al₂O₃ was used as reference. Thermal analysis were carried out in the 20 °C–1000 °C range with a constant heating rate of 10 °C min⁻¹. During the thermal analysis an appropriate fraction of the purging He flux, was continuously withdrawn and analyzed by the mass detector by using a silica deactivate capillary column (0.32 mm internal diameter, 13.5 m length) heated at 140 °C. Electron mass spectra (70 eV) were recorded with frequency of 1 scan s⁻¹ in the 1–400 amu range.

MS data were recorded as a continuous sequence of mass spectra. Any gas species released from the solid sample can be easily monitored by the detection of its fragmentation ion patterns leading to the total ion current (TIC) signal.

After pyrolysis the specimens were manually milled in an agate mortar. The obtained powders were characterized by x-ray diffraction using an Itaľstructures IPD3000 diffractometer (Itaľstructures, Arco, Italy) equipped with a Co anode source (line focus) coupled with a multilayer monochromator on the incident beam and an Inel CPS120 detector on the diffracted beam. Diffraction data were collected in reflexion geometry for 30 min and then modeled using the Maud [66] Rietveld software to extract quantitative information about crystalline phase composition and Si crystallite dimensions.

The composition and the chemical environments of the pyrolyzed samples were evaluated by x-ray photoelectron spectroscopy (XPS). The spectra were collected using an Axis DLD Ultra spectrometer (Kratos—Manchester UK). Analyses are composed by wide scans on a BE energy range 1300 to −5 eV using a 160 eV pass energy and high resolution (HR) core line spectra acquired at 20 eV pass energy and setting the energy step at 0.05 eV. Charge compensation was needed to
acquire spectra on these non-conducting samples. Spectra were aligned on the binding energy scale taking the C 1s at 284.6 eV as a reference.

HR-scanning transmission electron microscopy (STEM) experiments were performed on a C$_r$-corrected JEOL 2100 F microscope operating at 200 KeV.

Both PL and Raman analysis were performed on a Jobin-Ivon Aramis spectrophotometer, using a 532 nm laser as excitation source and a cooled CCD multichannel detector. Because of the rough powder surface, laser power has been adjusted on each measurement—with standard attenuation filters—to maximize either the PL or the Raman signal.

Third order nonlinear optical properties have been tested by measuring the PL stimulated by two photon absorption (TPA) processes. A pulsed laser (Katana HP by NKT Photonics) with 40 ps pulses at 100 MHz repetition rate, 0.9 mm spot diameter and with 1550 nm wavelength was used as source. The average power used was about 1 W, i.e. 250 W of peak power, with 10 nJ energy per pulse. The bright visible PL emitted by the powders was recorded in reflection and directly coupled into an SMA optical fiber connected with a spectrometer (Ocean Optics 2000+).

Chemical resistance against both harsh acid and basic environments was tested by immersing the powders (50–100 μm) for 48 h in either HF (0.9 M) and NaOH (1 M). For each annealing temperature, a known amount of powder (about 10 mg) has been placed in a cuvette and immersed in the etching solution. After the etching, the powder was washed and centrifuge three times, before being weighted.

3. Results

Figure 1 shows the TGA plot of the PHPS solution we prepared, i.e. a 80 wt% (PHPS)/20 wt% (DBE) solution, and its derivative (DTG); one can observe that a total weight loss about 37% is observed after pyrolysis to 1300 °C. Such weight loss appears to be associated to two main effects taking place at about 150 °C and 300 °C. At higher temperatures, no thermal effects are detected and the weight change is already achieved at 800 °C.

The MS analysis of the gases evolved during the TGA are reported in figure 2 and points out two main thermal effects which are strictly bounded to the ones observed in DTG. In particular, the total ion current (TIC) shows two maxima at about 140 °C and 320 °C. The first one is associated to DBE evolution, which starts from room temperature and ends at about 210 °C. The second TIC signal is related to the evolution of silane (SiH$_4$), ammonia (NH$_3$) and SiH$_3$–NH–SiH$_3$.

Figure 3 shows the XRD patterns of the specimens pyrolyzed in the temperature range from 950°C to 1250°C. Samples treated at 950 °C are x-ray amorphous. After a pyrolysis at 1050 °C, a very broad peak tends to emerge around 33° and the materials treated at 1150 and 1250 °C show the presence of three broad peaks at 2Θ = 33.16°; 55.54° and 69.59° which can be assigned to Si nanocrystals (ICSD 60385), with an estimated average volume-weighted crystallite size of 3.2 and 3.8 nm, respectively. Nonetheless, an amorphous background is still present at such high treating temperatures which can be tentatively associated with the
amorphous silicon nitride (Si₃N₄) matrix where the nanocrystals are embedded.

To confirm the phase composition of the amorphous matrix, the samples were annealed at 1400 °C for 2 h, to allow a complete matrix crystallization. The XRD spectrum, reported in figure 4, shows the strong crystalline reflections of α-Si₃N₄ (ICSD 6004), a marginal content of β-Si₃N₄ (<4 wt%) (ICSD 8263) and SiO₂ (< 2 wt%) (ICSD 47219) and, again, the presence of well-crystallized silicon. The results of the quantitative analysis are summarized in table 1.

The presence of silicon nanocrystals in the pyrolyzed samples is confirmed by the HR-STEM micrographs and by the corresponding fast Fourier transform patterns (figure 5). The crystallite size increases with the treating temperature. The trend of the XPS Si 2p spectra as a function of the temperature is reported in figure 6. The spectra point out that silicon is present in three different chemical states namely, Si₃N₄ at 101.6 eV, SiO₂ at 103.5 eV and Si at 99.2 eV. One can observe that the intensity of the component assigned to Si clearly increases with the treating temperature, consistently with the observed Si crystallization detected by XRD. However, the intensity of the Si peak of the specimens pyrolyzed at 1150 °C and 1250 °C is substantially the same, as pointed out by the inset in figure 6.

Figure 7 shows the results of the micro-Raman mapping of the nanocomposites. Each of the three points at each temperature is the average position of the Raman peak map—ped on about 120 points taken over an area of about 30 × 30 µm on single grains, while the error bars are the standard deviation of the peak position. Standard deviations assume rather large values on all samples, independently on the annealing temperature (albeit they decrease with the annealing temperature). This fact suggests that the local environment of the nc-Si is not homogeneous and that below 1150 °C the majority of the spots excite amorphous regions, while at temperature above 1150 °C, the crystalline phase

Table 1. Crystallographic phase composition for sample treated at 1400 °C as derived from XRD quantitative analysis (wt%).

<table>
<thead>
<tr>
<th>Phase</th>
<th>wt%</th>
</tr>
</thead>
<tbody>
<tr>
<td>α-Si₃N₄</td>
<td>80.6</td>
</tr>
<tr>
<td>β-Si₃N₄</td>
<td>4.2</td>
</tr>
<tr>
<td>Si</td>
<td>13.3</td>
</tr>
<tr>
<td>SiO₂</td>
<td>1.9</td>
</tr>
</tbody>
</table>
dominates and it shows the typical silicon Raman peak [67–70]. The inset of figure 7 reports representative line-shapes found at the different annealing temperatures. The average value of the Raman peak (left axis) represents the position of the broad amorphous band for samples annealed below $T_a$ (with $1050 < T_a < 1150 \, ^\circ\text{C}$), while it indicates the position of the crystalline peak for those treated at $T > T_a$ (as indicated by the right axis they represent the majority of the peaks in the two cases, respectively). Since the Raman signal shows largely different intensity on the excited domains, we choose a rather large laser intensity (about 10 mW $\mu\text{m}^{-2}$) to obtain reasonable signal-to-noise ratio on each of the investigated spots. Thus, all Raman peaks are blue-shifted by about 4–5 cm$^{-1}$ compared to their asymptotic signal measured at zero power. We check that this shift is perfectly reversible and that we are not heat-inducing modifications in the material (data not shown).

PL spectra of the pyrolyzed samples are reported in figure 8 (excitation wavelength 532 nm). One can observe the presence of a strong luminescence peak in the red-near infrared region. In our samples, the PL peak clearly red-shifts as temperature increases from 950 $^\circ\text{C}$ to 1150 $^\circ\text{C}$; temperatures greater than 1150 $^\circ\text{C}$ does not further shift the PL. The PL maxima are in detail located at 720, 760 and 800 nm for the samples treated at 950 $^\circ\text{C}$, 1050 $^\circ\text{C}$ and 1150 $^\circ\text{C}$/1250 $^\circ\text{C}$, respectively.

To check the robustness of the nc-Si in nitride matrix against intense optical excitation we perform a preliminary measure to verify the presence of nonlinear effects and to check for the stability of the nc-Si. Figure 9 shows the spectra of TPA stimulated PL emission. As for the linear PL, the maximum of the spectra shifts with the annealing temperature and the spectra of the samples pyrolyzed at 1150 $^\circ\text{C}$ and 1250 $^\circ\text{C}$ are substantially identical. The spectrum of the specimen treated at 950 $^\circ\text{C}$ is not reported because its optic response was not stable at the used excitation power densities (peak power density of 40 kW cm$^{-2}$).

The chemical resistance of the obtained materials was probed by etching the powders in HF and NaOH solutions for 48 h. The weight loss was found about 10 wt% in HF (regardless the annealing temperature), whereas no detectable weight changes were measured using the caustic soda solution. The PL response after etching was still present, even though the peak shape and position were slightly altered (supplementary material, figure S1 is available online at stacks.iop.org/NANO/30/255601/mmedia).

4. Discussion

The TGA plot in figure 1 shows the presence, during the thermal decomposition of PHPS solution of two main thermal effects at about 150 $^\circ\text{C}$ and 300 $^\circ\text{C}$. The former is attributed
the solvent evaporation, the latter to the loss of silane (SiH₄), ammonia (NH₃) and SiH₂–NH–SiH₁ units. Solvent evaporation is completed at about 210 °C, as confirmed by the MS analysis in figure 2. At such temperature the weight loss from TG is about 15 wt%, lower than the theoretical DBE load in the solution (20 wt%). Such deviation is due to the fact that DBE evaporation already started at room temperature under vacuum (see the DBE signal in figure 2), thus part of the solvent evaporates during the TGA chamber preparation before the beginning of the test. At higher temperatures, mainly between 200 °C and 400 °C, redistribution reactions between Si–H and Si–N take place leading to the formation of volatile species such as SiH₄, SiH₂–NH–SiH₁ and NH₃. It should be mentioned that redistribution reactions do not cause an increase of the crosslinking degree of the material. Indeed, the transformation from the pre-ceramic to the ceramic material should occur through radical reaction involving the breakage of Si–H and N–H bond and the formation of new Si–N and Si–Si bonds with H₂ release:

\[
\begin{align*}
\text{Si} - \text{H} & \rightarrow \text{Si} + \text{H}_2, \\
\text{N} - \text{H} & \rightarrow \text{N} + \text{H}_2.
\end{align*}
\]

The H₂ evolution, which certainly occurs during pyrolysis as reported in the literature [71], is not recorded by the MS due to the low sensitivity of our equipment for \(m/z\) below 4.

XRD plots in figure 3 point out that the pyrolysis product is amorphous at low pyrolysis temperatures (950 °C–1050 °C), but, when the temperature is increased (1150 °C–1250 °C), Si nanodots crystallization occurs. The nanocrystals are still embedded in an amorphous matrix, as confirmed by the broad features in the XRD patterns of the samples treated at 1150 °C and 1250 °C. The matrix contains few oxygen contamination, as confirmed by the XRD spectrum of the sample pyrolyzed at 1400 °C (figure 4) which shows α-Si₃N₄ and Si with only traces of and β-Si₃N₄ and crystalline silica.

XPS analysis, reported in figure 6, confirms the precipitation nc-Si from the silicon nitride matrix. As a matter of fact, Si signal at 99.2 eV is detected in all the tested specimens but it progressively increases with the annealing temperature, thus pointing out the thermally-activated formation of nc-Si. The SiO₂ shoulder at about 103.5 eV is likely associated to surfaces contaminations, indeed very few silica has been detected on the completely crystallized sample (figure 4). A further proof of the nc-Si formation is given by the Raman spectra, showing the characteristic features of nanocrystalline silicon [67–70] at about 500 cm⁻¹ (pyrolysis at 950 °C and 1050 °C) and 515 cm⁻¹ (pyrolysis at 1150 °C and 1250 °C).

To understand the nanocomposite formation one should consider that the nominal composition of the ceramic obtained through PHS decomposition—assuming that only H₂ is removed—is Si₃N₄ (Si to N ratio 1:1), PHS being constituted by linear chains of (SiH₂–NH–) units. Indeed, such stoichiometry is not expected from the Si/N phase diagram, stoichiometric silicon nitride having a chemical formula Si₃N₄. Therefore, it is possible to obtain a 'silicon-rich silicon nitride' from the PHS thermal decomposition. It is however worth mentioning that some deviations from the exact Si:N ratio 1:1 are expected because of the evolution of SiH₄, NH₃ and SiH₂–NH–SiH₁ during pyrolysis, thus we will refer to the pyrolysis product as Si₃N₄ (with \(y > 3\)).

When the annealing temperature is low the diffusion kinetics are not fast enough to produce a complete phase separation and a homogenous amorphous matrix is obtained with composition Si₃N₄. In such disordered network, the silicon chemical bonds might be partially saturated through the formation of Si–Si covalent bonds, the material being nitrogen deficient.

However, as temperature increases clusters of silicon atoms bonded only with other silicon start to be formed. Hence, the matrix becomes progressively more stoichiometric and, more important, nc-Si nucleates. The silicon nanodots growth is therefore ruled by a phase separation reaction (exsolution) taking place in the silicon-abundant amorphous matrix:

\[
\text{Si}_3\text{N}_3\square \square \text{Si}_3\text{N}_4 + (y - 3)\text{Si}; \quad \text{with } y > 3.
\]

The stoichiometric reaction, starting from a matrix with the nominal compositional SiN, predicts a Si load in the composite of 15.9 wt%; such value appears in rather good agreement with the quantitative XRD analysis (spectrum in figure 3), which points out a Si content of 13.3 wt%. Hence, we can suggest that the ceramic obtained through PHS decomposition has a Si to N ratio not far from the nominal one (1:1); in other words, the evolution of SiH₄, NH₃ and SiH₂–NH–SiH₁ during the thermal treatment does not cause a strong deviation from the SiN stoichiometry. Above 1000 °C and up to 1300 °C the TGA does not show any weight loss confirming that the observed matrix crystallization occurs without any decomposition or reduction reaction.

nc-Si already start to form at 950 °C–1050 °C, as highlighted by the shoulder on the XPS spectra at about 99.2 eV that is associated to Si-Si bonds. This is consistent with the presence of the Raman feature at about 500 cm⁻¹, which points out the existence of Si nanoclusters. A further confirmation of the presence of nc-Si is given by the TEM micrographs of the sample annealed at 1050 °C (figure 5). However, the large scattering of the micro-Raman peak position in these samples suggests the coexistence of nanocrystals with broad size distribution. Such dispersion of the crystallite size in the low-annealing temperature materials seems consistent with the XRD and HR-STEM analysis. As a matter of fact, HR-STEM micrographs revealed the presence of some ‘quite large’ crystals, in the order of 3 nm, in the sample treated at 1050 °C (figure 5), whose XRD spectrum showed only amorphous features (figure 3). This difference is likely due to the better sensitivity of HR-STEM to large crystallites, whereas sub-nanometric clusters are difficult to be observed. This is also due to the low TEM contrast between nc-Si and the silicon nitride matrix, which makes very difficult the identification of the smallest Si nanocrystals. Moreover the micro-Raman nc-Si signal, detected only in about 10% of the tested regions on the samples treated at 950 and
1050 °C, is consistent with the existence some microstructural inhomogeneity. The origin of this feature is not completely clear; however one can propose that it may be associated to small variations of the ceramic composition during pyrolysis (i.e., different release rate of the gasses from the surface and the core of the material) or to preferential nanocrystals nucleation in determined loci (i.e. surface-assisted nucleation). Further, studies are needed to clarify this effect.

When the treating temperature increases the phase separation proceeds and the Si clusters growth, thus increasing the XPS signal at 99.2 eV and producing clear nanocrystalline features in the XRD spectra. This causes also the Raman peak shift from 500 cm\(^{-1}\) (pyrolysis at 950 °C–1050 °C) to 515 cm\(^{-1}\) (pyrolysis at 1150 °C–1250 °C), which points out an increase of the crystals size [67–70] with the treating temperature. Finally, if the pyrolysis temperature is higher than 1150 °C both XRD, Raman and XPS spectra get stablized: the crystallite size, detected by XRD, and the intensity of the XPS peak at 99.2 eV are substantially the same for the samples treated at 1150 °C and 1250 °C. This points out that: (i) the silicon precipitation from the nonstoichiometric amorphous matrix is almost completed at 1150 °C and (ii) the obtained material presents an excellent thermal stability, the nanocrystals size being substantially unvaried between 1150 °C and 1250 °C. Indeed, if one assumes that the Si precipitation from the matrix is already completed at 1150 °C, the only coarsening mechanism becomes Oswald ripening which is likely slower than the exsolution process.

The origin of the PL from nc-Si in nitride matrix is debated since long time. The simple quantum-in-a-box problem predicts a redshift of the energy level of nc-Si embedded in nitride matrix compared to the oxide case (since the smaller energy gap of the former). But the vast majority of publications on nc-Si in nitride synthesize the samples by CVD techniques and the size of the nc-Si is defined by the thickness of the silicon rich layer. Thus strong interfacial stress develop at each interface and it is known that mechanical stress heavily affect the optical properties of the nanoparticles by increasing the quantum confinement effect [72]. In fact, a recent publication demonstrated that nc-Si capped with silicon nitride layer show the typical PL of silicon quantum dots [73]. Curiously, despite the large difference between what would be expected from fundamental quantum mechanics and the experimental results, several works still use the typical equation that correlates the increase of the band gap with the inverse of the square of the nc-Si size (which, at this point, is nothing more than a phenomenological power law).

Our optical analysis is well-aligned with the structural characterization and it supports the basics results expected for nc-Si embedded in a dielectric matrix:

i. The PL and NL peaks move toward higher wavelength when the treating temperature increases: this is a typical manifestation of the quantum-confinement effect, where the band gap (and the emitted photon energy) decreases when the crystallite size is increased [5, 44, 46, 74–76]; albeit it might be mediated by surface states. As for the above reported structural analysis, a stabilization of the optical signals is obtained when the pyrolysis temper- ature is above 1150 °C, confirming, once again, a structural stabilization above such temperature.

ii. PL peaks are slightly red-shifted compared to the traditional PL spectra obtained from similar sized nc-Si in SiO\(_2\) matrix [77, 78]. Although qualitative, such result supports the smaller confinement of excitons in nitride compare to oxides. Given the complex structure of radiative defects in nitride matrix, we cannot exclude completely their role from the emission but both the structural analysis and the optical characterization points out the typical response of crystalline nc-Si. Yet, it is worth noting that the PL peaks fall well beyond the typical region of nitride luminescent defects and cannot be ascribe to them [52] (at least for the samples treated at 1050 °C, 1150 °C and 1250 °C). Thus we suggest our synthesis route might be appealing to further study to definitively clarify fundamental aspects of crystalline nc-Si in amorphous silicon nitride matrix. However, the large blue shift of the PL from samples annealed at 950 °C and its limited stability under large excitation fluences (see nonlinear characterization below) suggest that this signal might partially originate from defects or defect clusters that disappear at higher annealing temperatures.

A preliminary check of the NL optical properties of this material is reported in figure 9 and points out that the obtained nanocomposites, excluding the one pyrolyzed at 950 °C, are suitable for nonlinear optical applications. The PL was stimulated by TPA mechanism by exciting the sample with a IR pulsed laser at power density of about 40 kW cm\(^{-2}\). All samples but the one annealed at the lowest temperature show a bright and stable visible PL under IR pumping, scaling at lower wavelength when increasing the pyrolysis temperature. The long tail at shorter wavelengths might be due to multiphoton processes and radiative paths mediated by defects; while the complex shape of the nonlinear PL spectra requires a careful investigation and the optimization of the synthesis to produce samples with less defects. Albeit this is a preliminary result obtained on powders, the bright PL and its very good stability, confirm that the NL properties of the nc-Si are not quenched by the synthesis methods and the samples are highly stable even under high pump fluences, probably because of the highly refractory properties of the silicon nitride matrix.

The chemical resistance was found to be outstanding both in HF and NaOH solutions. Such chemical environments would cause an extremely rapid dissolution of the commonly produced nc-Si@a-SiO\(_2\), whereas nc-Si@a-SiN\(_x\) powder obtained in this work resisted for a long time (48 h) in concentrated solutions. Also the PL response after etching in such severe conditions was still maintained. The obtained materials are therefore characterized by superior chemical properties and could operate in extremely harsh environments.

5. Conclusions
In this work we show, for the first time, the direct nucleation of nc-Si embedded in a silicon nitride matrix. We exploit the pyrolysis of a pre-ceramic polymer (perhydropolysilazane) in protective atmosphere to obtain highly luminescent nanocomposites. We characterize the material both structurally and optically and we show that nc-Si maintains both its linear and nonlinear optical properties also when surrounded by a nitride phase. All samples show a bright PL that shifts with the annealing temperature accordingly to the quantum confinement effect and that nc-Si shows intense nonlinear response. Albeit on a preliminary level, these two evidences support the idea that nc-Si formed from the pyrolysis of a pre-ceramic polymer maintain the basic optical properties as for nc-Si nucleated in silica matrix. Moreover, we show that nitride composites have a much stronger chemical resistance to both acidic and basic environments, where the ‘traditional’ oxide based silicon nanomaterials are corroded.

Unfortunately neither can we perform time resolved measurements since the samples are not of optical quality, nor can we quantify the PL yield. Thus further characterizations are needed to definitively unveil the origin of the PL from nc-Si embedded in bulk amorphous nitride matrix free from the interfacial stress that is surely induced in thin multilayer structures and that might be significantly different from the interfacial stress between the single nc-Si and the amorphous, bulk nitride surroundings.

Our synthesis greatly eases the production of nitride embedded nc-Si and it will contribute to stimulate both fundamentals as well as applied science to produce high quality nc-Si easily engineered into active components (such as large area films, fibers and others). Once optimized, this synthesis route would allow a massive, rapid, flexible and easy production of nc-Si in SiNₓ, substantially surpassing the productivity and shape limitations of the traditional synthesis based on physical or chemical vapor deposition methods.

References


[54] Zelenina A et al 2013 Structural and optical properties of size controlled Si nanocrystals in SiN2x matrix: the nature of photoluminescence peak shift J. Appl. Phys. 114 184311


